



Finishing

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| Surface Finishes | ENIG HAL(lead free) HAL(leaded) OSP |
| Maximum Gold Thickness | ENIG 3 μ inch Selective Gold 60 μ inch |
| Solder Mask | Wet Film (Green,red,blue,black,white) |
| Minimum Solder Mask Clearance | 3 mil |
| Other Printing | Solder Mask Plugged Hole Component Mark Carbon Ink (20 – 80 Ω) Peelable Mask |